

Datasheet

MODEL NAME	CRI	CCT	SEC CODE
V Series Gen3 V562C Ver	80	30/35/40/5000K	SI-B8x123560WW
V Series Gen3 VB22C Ver	80	30/35/40/5000K	SI-B8x243B20WW
V Series Gen3 VB22F Ver	80	30/35/40/5000K	SI-B8x463B20WW
V Series Gen3 VB24F Ver	80	30/35/40/5000K	SI-B8x923B20WW

SAMSUNG				CUSTOMER
DEVELOP.	PRODUCT MANAGER	QA(DQA)	SALES	

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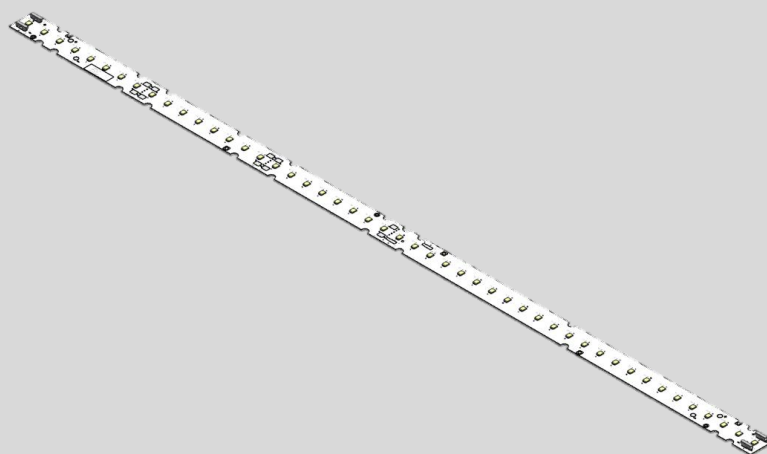
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Rev	Remark	Page	Date	Traced
1.0	The First Specification established.	ALL	21.04.08.	JK Lee

LED Module

V Series Gen3 Ver.



Features & Benefits

- Design flexibility for module length by cuttable design
- 2835 Pro of high degree of reliability & long lifetime
- Four variations of 2200/4400/8000/16000lm
- High efficacy up to 187 lm/W



Application

- Office, Building, Education
- Troffer, Linear, Line
- Highbay/Lowbay for warehouse, plant, high ceiling etc

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1. Product Code Information

a) V562C

Nominal CCT (K)	Product Code
3000	SI-B8V123560WW
3500	SI-B8U123560WW
4000	SI-B8T123560WW
5000	SI-B8R123560WW

b) VB22C

Nominal CCT (K)	Product Code
3000	SI-B8V243B20WW
3500	SI-B8U243B20WW
4000	SI-B8T243B20WW
5000	SI-B8R243B20WW

c) VB22F

Nominal CCT (K)	Product Code
3000	SI-B8V463B20WW
3500	SI-B8U463B20WW
4000	SI-B8T463B20WW
5000	SI-B8R463B20WW

d) VB24F

Nominal CCT (K)	Product Code
3000	SI-B8V923B20WW
3500	SI-B8U923B20WW
4000	SI-B8T923B20WW
5000	SI-B8R923B20WW

2. Characteristics

a) Basic Information

Item	Rating	Unit	Remark
Rated Lifetime	>50,000	hour	L70B50@ $t_p \leq 80^\circ\text{C}$, Rated current
Ingress Protection (IP)	no rating	-	
Ambient / Operating Temperature (t_a)	-20 ~ +50	$^\circ\text{C}$	V562C, VB22C
	-40 ~ +65	$^\circ\text{C}$	VB22F, VB24F
Storage Temperature	-30 ~ +80	$^\circ\text{C}$	V562C, VB22C
	-40 ~ +85	$^\circ\text{C}$	VB22F, VB24F
Isolation Breakdown Voltage	Min. 500	Vac	

Notes:

- ※ I_f : Forward current or Operating current
- ※ t_p : temperature at which performance is specified measured at "Tc point".
- ※ t_a : ambient temperature

b) Electro-Optical Characteristics

- V562C

Item	Nom. CCT (K)	Rating			Unit	Remark
		Min	Typ.	Max		
Luminous Flux	3000	1930	2080	2280	lm	$I_f = 530\text{mA}$ $t_p = 50^\circ\text{C}$
	3500	1960	2110	2320		
	4000	2020	2200	2420		
	5000	2050	2200	2420		
Luminous Efficacy	3000	164	176	193	lm/W	
	3500	166	179	197		
	4000	171	186	205		
	5000	174	186	205		
Color Rendering Index (Ra)	-	80	-	-	-	-
Operating Current (I_f)	-	50	530	1800	mA	-
Operating Voltage (V_f)	-	20.4	22.2	23.5	Vdc	$I_f = 530\text{mA}$ $t_p = 50^\circ\text{C}$
Power Consumption	-	10.8	11.8	12.5	W	

- VB22C

Item	Nom. CCT (K)	Rating			Unit	Remark
		Min	Typ.	Max		
Luminous Flux	3000	3870	4160	4570	lm	$I_f = 530\text{mA}$ $t_p = 50^\circ\text{C}$
	3500	3930	4220	4640		
	4000	4030	4400	4840		
	5000	4090	4400	4840		
Luminous Efficacy	3000	165	177	194	lm/W	
	3500	167	180	197		
	4000	171	187	206		
	5000	174	187	206		
Color Rendering Index (Ra)	-	80	-	-	-	-
Operating Current (I_f)	-	50	530	1800	mA	-
Operating Voltage (V_f)	-	40.8	44.4	47.0	Vdc	$I_f = 530\text{mA}$
Power Consumption	-	21.6	23.5	24.9	W	$t_p = 50^\circ\text{C}$

- VB22F

Item	Nom. CCT (K)	Rating			Unit	Remark
		Min	Typ.	Max		
Luminous Flux	3000	7050	7570	8320	lm	$I_f = 1010\text{mA}$ $t_p = 65^\circ\text{C}$
	3500	7150	7680	8440		
	4000	7340	8000	8800		
	5000	7440	8000	8800		
Luminous Efficacy	3000	155	166	183	lm/W	
	3500	157	169	185		
	4000	161	176	193		
	5000	164	176	193		
Color Rendering Index (Ra)	-	80	-	-	-	-
Operating Current (I_f)	-	100	1010	2020	mA	-
Operating Voltage (V_f)	-	40.8	45.0	47.8	Vdc	$I_f = 1010\text{mA}$
Power Consumption	-	41.2	45.5	48.3	W	$t_p = 65^\circ\text{C}$

- VB24F

Item	Nom. CCT	Rating			Unit	Remark
	(K)	Min	Typ.	Max		
Luminous Flux	3000	14110	15140	16650	lm	$I_f = 2020\text{mA}$ $t_p = 65^\circ\text{C}$
	3500	14300	15360	16890		
	4000	14670	16000	17600		
	5000	14860	16000	17600		
Luminous Efficacy	3000	155	167	183	lm/W	
	3500	157	169	186		
	4000	161	176	194		
	5000	163	176	194		
Color Rendering Index (Ra)	-	80	-	-	-	-
Operating Current (I_f)	-	200	2020	2020	mA	-
Operating Voltage (V_f)	-	40.8	45.0	47.8	Vdc	$I_f = 2020\text{mA}$
Power Consumption	-	82.4	90.9	96.6	W	$t_p = 65^\circ\text{C}$

Notes

- 1) t_p : temperature at which performance is specified; measured at "tc".
- 2) Samsung maintains a measurement tolerance of : Luminous flux: $\pm 7\%$, CRI: ± 3.0 , Voltage: $\pm 0.3\text{ V}$, Power Consumption: $\pm 0.3\text{W}$

c) Color Coordinate

- V562C, VB22C

Model	Nom. CCT (K)	CIE 1931 Chromaticity Coordinates				Remark	
V Series Gen3	3000	CIE x	0.4388	0.4461	0.4335	0.4266	I _F = 530 mA t _p = 25 °C
		CIE y	0.3967	0.4118	0.4072	0.3924	
		Center	CIE x	0.4363	CIE y	0.4020	
	3500	CIE x	0.4132	0.4192	0.4055	0.4001	
		CIE y	0.3857	0.4009	0.3940	0.3794	
		Center	CIE x	0.4095	CIE y	0.3900	
	4000	CIE x	0.3887	0.3929	0.3803	0.3767	
		CIE y	0.3755	0.3900	0.3822	0.3683	
		Center	CIE x	0.3847	CIE y	0.3790	
	5000	CIE x	0.3511	0.3524	0.3431	0.3423	
		CIE y	0.3517	0.3649	0.3569	0.3454	
		Center	CIE x	0.3472	CIE y	0.3547	

- VB22F, VB24F

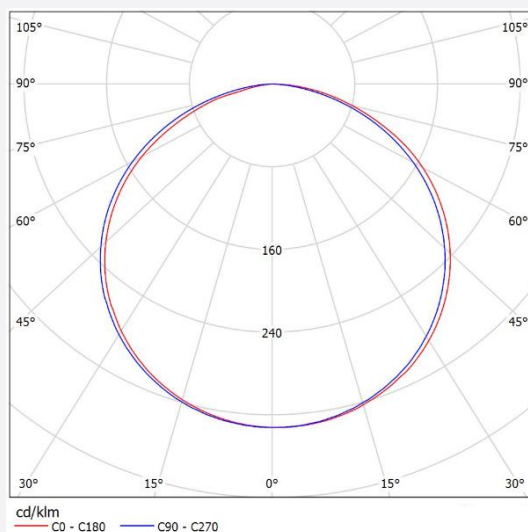
Model	Nom. CCT (K)	CIE 1931 Chromaticity Coordinates				Remark	
V Series Gen	3000	CIE x	0.4382	0.4455	0.4329	0.4260	VB22F I _F = 1010 mA VB24F I _F = 2020 mA t _p = 25 °C
		CIE y	0.3964	0.4115	0.4069	0.3921	
		Center	CIE x	0.4357	CIE y	0.4017	
	3500	CIE x	0.4130	0.4190	0.4053	0.3999	
		CIE y	0.3855	0.4007	0.3938	0.3792	
		Center	CIE x	0.4093	CIE y	0.3898	
	4000	CIE x	0.3884	0.3926	0.3800	0.3764	
		CIE y	0.3751	0.3896	0.3818	0.3679	
		Center	CIE x	0.3844	CIE y	0.3786	
	5000	CIE x	0.3509	0.3522	0.3429	0.3421	
		CIE y	0.3513	0.3645	0.3565	0.3450	
		Center	CIE x	0.3470	CIE y	0.3543	

Notes

- 1) Samsung maintains a measurement tolerance of CIE_x / CIE_y ± 0.005

d) Light Distribution

Item	Unit	Nominal	Tolerance	Remark
Beam Angle (FWHM)	°(degree)	118	± 5	



e) Temperature Characteristics

- V562C, VB22C

Item	Nominal(t_p)*	Life(t_L)**	Max(t_c)***	Unit
Temperature	50	80	90	°C

- VB22F, VB24F

Item	Nominal(t_p)*	Life(t_L)**	Max(t_c)***	Unit
Temperature	65	80	90	°C

Notes

* Temperature used to specify performance of the module (t_p).

** Rated maximum performance temperature at which lifetime is specified in L70B50 (t_L).

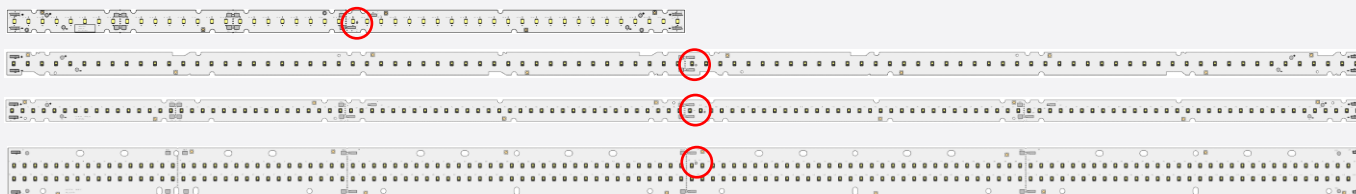
*** Rated maximum temperature, highest permissible temperature to avoid safety risk (t_c).

All temperatures are measured at the designated "tc" as indicated on the module. (See page 6)

Please use heat-sink(or heat dissipation solution) with proper thermal capacity(operating wattage).

f) Thermal Measurement

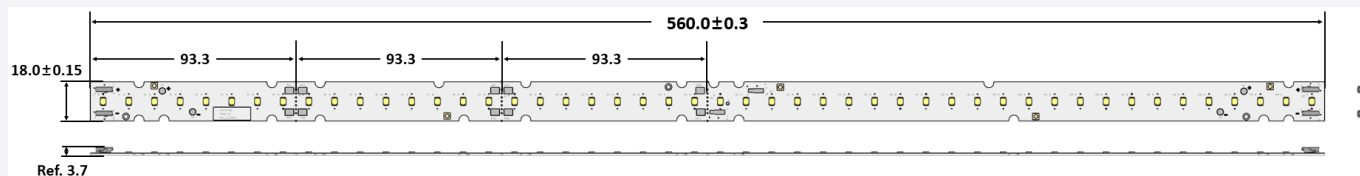
Performance temperatures are measured on "Tc point" as indicated on the module.



3. Structure and Assembly

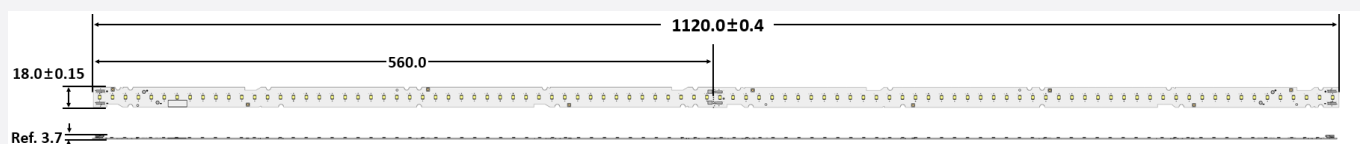
a) Appearance & Dimension

- V562C



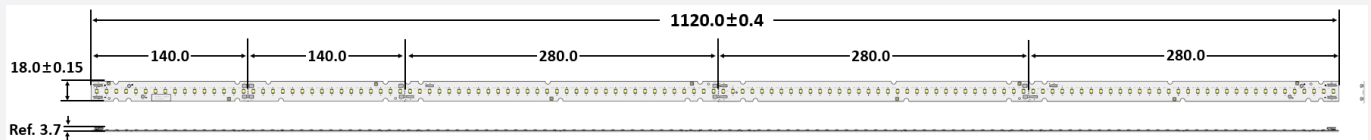
Dimension	Specification	Tolerance	Unit
Module Length	560.0	±0.3	mm
Module Width	18.0	±0.15	mm
Module Height	3.7	±0.2	mm
PCB Thickness	1.0	±0.1	mm
Module Weight	21.0	±1.1	g

- VB22C



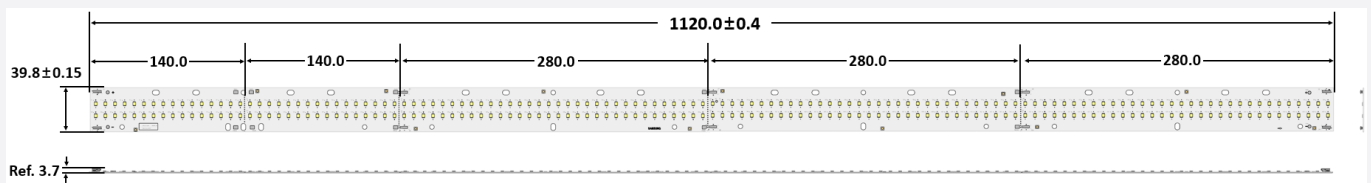
Dimension	Specification	Tolerance	Unit
Module Length	1120.0	±0.4	mm
Module Width	18.0	±0.15	mm
Module Height	3.7	±0.2	mm
PCB Thickness	1.0	±0.1	mm
Module Weight	42.0	±2.1	g

- VB22F



Dimension	Specification	Tolerance	Unit
Module Length	1120.0	±0.4	mm
Module Width	18.0	±0.15	mm
Module Height	3.7	±0.2	mm
PCB Thickness	1.0	±0.1	mm
Module Weight	42.0	±2.1	g

- VB24F



Dimension	Specification	Tolerance	Unit
Module Length	1120.0	±0.4	mm
Module Width	39.8	±0.15	mm
Module Height	3.7	±0.2	mm
PCB Thickness	1.0	±0.1	mm
Module Weight	91.0	±4.6	g

b) Structure

Item	Specification
LED	LM281B+ Pro Middle Power LED
PCB	CEM-3 PCB
Connector	1pin poke-in type

c) Schematic Circuit

- V562C 8S x 6P
- VB22C 16S x 6P
- VB22F 16S x 8P
- VB24F 16S x 16P

d) Handling Guide

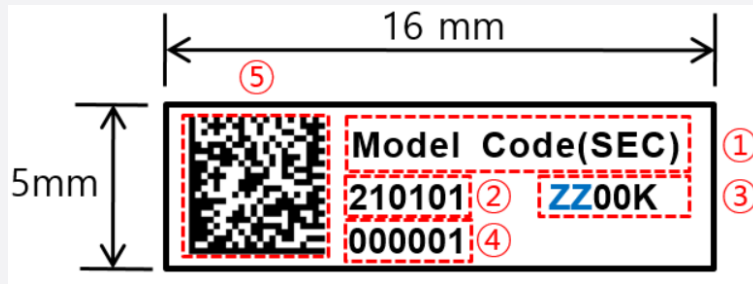
- * Please use antistatic gloves or other ESD protection methods when handling this cuttable board to prevent ESD damage or contamination of LEDs.
- * Customers should use proper tools and not use hands when they separate this cuttable board. It is not allowed to bend PCB and touch LED.
- * Please be thoughtful of securing withstanding voltage spec in case of cutting this board.
- * If customers don't follow above guideline regarding handling, we won't be responsible for any quality issue.
- * It is necessary to use after insulation work when exposed to insulating layer on PCB section.

4. Certification and Declaration

Item	Compliant to	Remark
Certification	UL/cUL	E344519 Input Types(Input supply limitations) : Class 2
Declaration	RoHS	Hazardous Substance & Material

5. Label Structure

a) Module Label



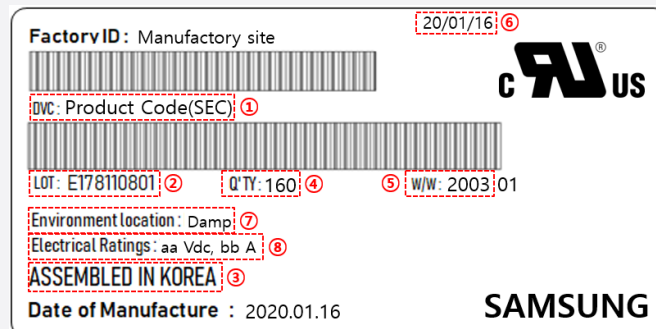
Number	Item	Remark
①	Model code	Refer to page 3
②	Date of manufacture	YYMMDD
③	Color temperature	ZZ = 30, 35, 40, 50
④	Series number	000001~999999; Setting "000001" every working day
⑤	QR code	V562C : SI-B8X123560WW YYMMDD ZZ00K 000001 VB22C : SI-B8X243B20WW YYMMDD ZZ00K 000001 VB22F : SI-B8X463B20WW YYMMDD ZZ00K 000001 VB24F : SI-B8X923B20WW YYMMDD ZZ00K 000001

b) Tray & MBB Bag Label



Number	Item	Remark
①	Model Code	Refer to page 3
②	LOT ID	
③	Quantity	Refer to page 15
④	Date of production	
⑤	Date of Issue	
⑥	Place of origin	

c) Box Label



Number	Item	Remark
①	Product Code	Refer to page 3
②	LOT ID	
③	Place of origin	
④	Quantity	Refer to page 15
⑤	Describe production week	
⑥	Date of Issue	
⑦	Environment location	Damp
⑧	Electrical Ratings (voltage/current)	V562C 28Vdc, 1.8A VB22C 55Vdc, 1.8A VB22F 49Vdc, 2.02A VB24F 49Vdc, 2.02A

6. Packing Structure

Product	Packing	Quantity (modules)	Dimension (mm)		
			Length	Width	Height
V562C	Tray	40 ea	600	444	25
	Outer Box	280 ea	605	449	155
	Pallet	5600 ea	1100	1100	130
VB22C/VB22F	Tray	11 ea	1180	310	22
	Outer Box	110 ea	1185	315	163
	Pallet	1650 ea	1200	1000	130
VB24F	Tray	6 ea	1180	310	22
	Outer Box	60 ea	1185	315	163
	Pallet	900 ea	1200	1000	130

7. Precautions in Handling & Use

- 1) This LED Module should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA is recommended to use. When using other solvents it should be confirmed beforehand whether the solvents may react with the Module material. The banned Freon solvents should not be used. Do not clean using ultrasonic cleaner.
- 2) The LEDs are sensitive to the static electricity and surge. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED Modules. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leak current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 3) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires (fixtures). In order to prevent these problems, we recommend users to know the physical properties of the materials used in luminaires, and they must be selected carefully.
- 4) Risk of sulfurization (or tarnishing)
The LED uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, the LED Modules should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.
- 5) The resin area is very sensitive, please do not handle, press, touch or rub it.
- 6) Do not drop the Module or give shocks.
- 7) Do not store the Module in a dusty place or humid location.
- 8) Do not disassemble the Module.
- 9) Do not directly look into the lighted LED with naked eyes for a long period of time.
- 10) Please consider the creepage and clearance distance at the end product.
- 11) Solder ball
There might be solder ball and/or residue on the surface of module as long as they do NOT affect performance and safety.
- 12) When you install products in fixture, you should not connect the product while it is powered on. It will cause damage Circuits(that LED is included) and result in emitting smoke and ignition.

[Appendix]

1. Applicable Solid Wire Information

a) Strip details

Connection method	Push In
Solid Conductor	0.2-0.75mm ² / 24-18 AWG
Strip length	8.5±1mm
Conductor entry angle to the PCB	0 °

b) Important processing notes

Depending on the SMD soldering process and associated parameters a minor discoloration might occur. However, this will not influence the functionality.

2. Connection

Product	Max parallel	Max series	Remark
V562C	1	4	Operating current / module = 1.8A
VB22C	1	4	Operating current / module = 1.8A
VB22F	1	4	Operating current / module = 2.02A
VB24F	1	4	Operating current / module = 2.02A

※ The type of screw to be used is not considered.

Legal and additional information.

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